

FST16213 24-Bit Bus Exchange Switch

General Description

The Fairchild Switch FST16213 provides 24-bits of high-speed CMOS TTL-compatible bus switching or exchanging. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

The device operates as a 24-bit bus switch or a 12-bit bus exchanger, which allows data exchange between the four signal ports via the data-select terminals.

Features

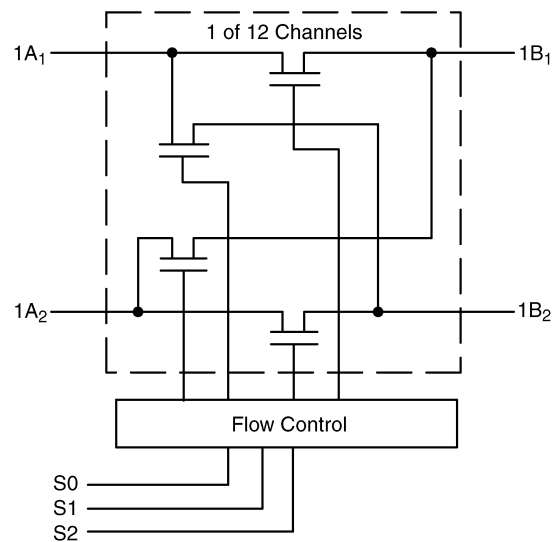
- 4Ω switch connection between two ports.
- Minimal propagation delay through the switch.
- Low I_{CC} .
- Zero bounce in flow-through mode.
- Control inputs compatible with TTL level.

Ordering Code:

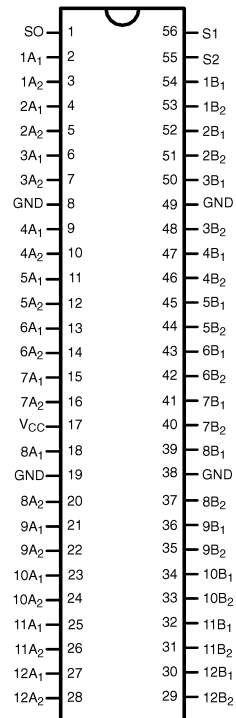
Order Number	Package Number	Package Description
FST16213MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide
FST16213MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Diagram



Connection Diagram



Pin Descriptions

Pin Name	Description
S2, S1, S0	Data-select inputs
A ₁ , A ₂	Bus A
B ₁ , B ₂	Bus B

Truth Table

S2	S1	S0	A ₁	A ₂	Function
L	L	L	Z	Z	Disconnect
L	L	H	B ₁	Z	A ₁ = B ₁
L	H	L	B ₂	Z	A ₁ = B ₂
L	H	H	Z	B ₁	A ₂ = B ₁
H	L	L	Z	B ₂	A ₂ = B ₂
H	L	H	A ₂ and B ₂	A ₁ and B ₂	A ₁ = A ₂ = B ₂
H	H	L	B ₁	B ₂	A ₁ = B ₁ , A ₂ = B ₂
H	H	H	B ₂	B ₁	A ₁ = B ₂ , A ₂ = B ₁

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Switch Voltage (V_S)	−0.5V to +7.0V
DC Input Voltage (V_{IN}) (Note 2)	−0.5V to +7.0V
DC Input Diode Current (I_{IK}) $V_{IN} < 0V$	−50mA
DC Output (I_{OUT}) Sink Current	128mA
DC V_{CC} /GND Current (I_{CC}/I_{GND})	+/- 100mA
Storage Temperature Range (T_{STG})	−65°C to +150 °C

Recommended Operating Conditions (Note 3)

Power Supply Operating (V_{CC})	4.0V to 5.5V
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to 5.5V
Input Rise and Fall Time (t_r , t_f)	
Switch Control Input	0nS/V to 5nS/V
Switch I/O	0nS/V to DC
Free Air Operating Temperature (T_A)	−40 °C to +85 °C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused control inputs must be held high or low. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = -40\text{ °C to }+85\text{ °C}$			Units	Conditions
			Min	Typ (Note 4)	Max		
V_{IK}	Clamp Diode Voltage	4.5			−1.2	V	$I_{IN} = -18mA$
V_{IH}	HIGH Level Input Voltage	4.0–5.5	2.0			V	
V_{IL}	LOW Level Input Voltage	4.0–5.5			0.8	V	
I_I	Input Leakage Current	5.5			±1.0	μA	$0 \leq V_{IN} \leq 5.5V$
		0			10	μA	$V_{IN} = 5.5V$
I_{OZ}	OFF-STATE Leakage Current	5.5			±1.0	μA	$0 \leq A, B \leq V_{CC}$
R_{ON}	Switch On Resistance A to B or B to A (Note 5)	4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 64mA$
		4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 30mA$
		4.5		8	12	Ω	$V_{IN} = 2.4V, I_{IN} = 15mA$
		4.0		11	20	Ω	$V_{IN} = 2.4V, I_{IN} = 15mA$
	Switch On Resistance A1 to A2 (Note 5)	4.5		10	14	Ω	$V_{IN} = 0V, I_{IN} = 64mA$
		4.5		10	14	Ω	$V_{IN} = 0V, I_{IN} = 30mA$
		4.5		16	22	Ω	$V_{IN} = 2.4V, I_{IN} = 15mA$
		4.0		22	30	Ω	$V_{IN} = 2.4V, I_{IN} = 15mA$
I_{CC}	Quiescent Supply Current	5.5			3	μA	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$
ΔI_{CC}	Increase in I_{CC} per Input	5.5			2.5	mA	One input at 3.4V Other inputs at V_{CC} or GND

Note 4: Typical values are at $V_{CC} = 5.0V$ and $T_A = +25^\circ C$

Note 5: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Electrical Characteristics

Symbol	Parameter	T _A = −40 °C to +85 °C, C _L = 50pF, R _U = R _D = 500Ω				Units	Conditions	Figure No.
		V _{CC} = 4.5 – 5.5V		V _{CC} = 4.0V				
		Min	Max	Min	Max			
t _{PHL} , t _{PLH}	Prop Delay Bus to Bus (Note 6)		0.25		0.25	ns	V _I = OPEN	Figure 1 Figure 2
t _{PHL} , t _{PLH}	Prop Delay A1 to A2		0.5		0.5	ns	V _I = OPEN	Figure 1 Figure 2
t _{PZH} , t _{PZL}	Output Enable Time, S to A or B	1.5	7.5		8.0	ns	V _I = 7V for t _{PZL} V _I = OPEN for t _{PZH}	Figure 1 Figure 2
t _{PHZ} , t _{PLZ}	Output Disable Time S to A or B	1.0	8.5		9.0	ns	V _I = 7V for t _{PLZ} V _I = OPEN for t _{PHZ}	Figure 1 Figure 2
t _{PZH} , t _{PZL}	Output Enable Time, S0 to A2 and B2	1.5	9.5		10.0	ns	V _I = 7V for t _{PZL} V _I = OPEN for t _{PZH}	Figure 1 Figure 2
t _{PHZ} , t _{PLZ}	Output Disable Time, S0 to A2 and B2	1.5	9.0		10.0	ns	V _I = 7V for t _{PLZ} V _I = OPEN for t _{PHZ}	Figure 1 Figure 2

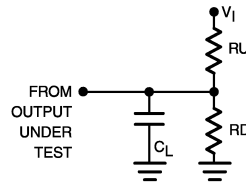
Note 6: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Capacitance (Note 7)

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Control pin Input Capacitance	3		pF	$V_{CC} = 5.0\text{V}$
$C_{I/O}$	Input/Output Capacitance	10		pF	$V_{CC} = 5.0\text{V}$ S0, S1, or S2 = GND

Note 7: $T_A = +25^\circ\text{C}$, $f = 1\text{ MHz}$, Capacitance is characterized but not tested.

AC Loading and Waveforms



Note: Input driven by 50Ω source terminated in 50Ω

Note: C_L includes load and stray capacitance

Note: Input PRR = 1.0 MHz , $t_W = 500\text{ ns}$

FIGURE 1. AC Test Circuit

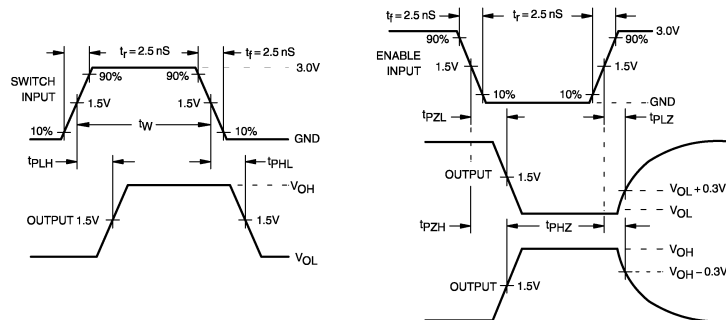
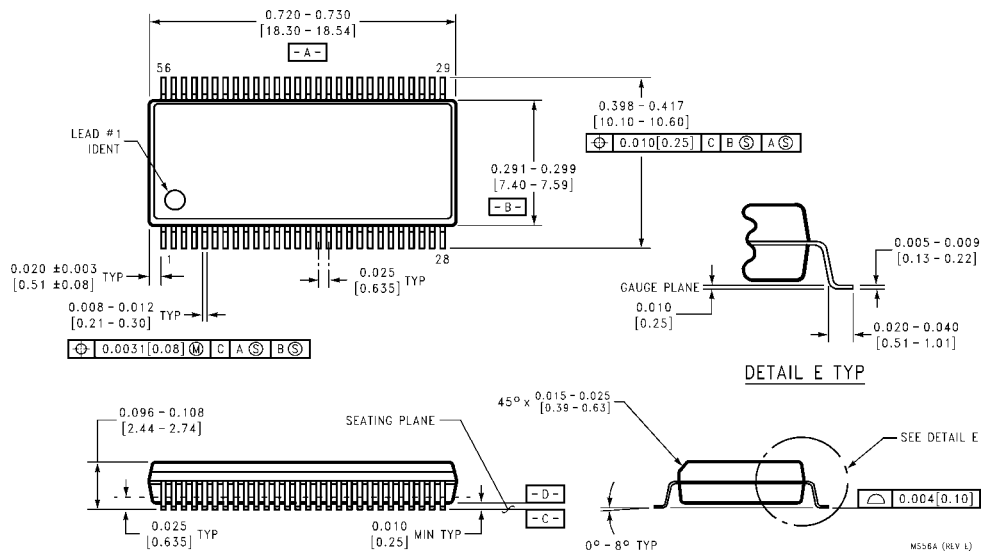


FIGURE 2. AC Waveforms

Physical Dimensions inches (millimeters) unless otherwise noted



56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide
Package Number MS56A

The drawing illustrates the mechanical specifications for a 28-pin DIP package. The top view shows a rectangular body with pins on all four sides. Key dimensions include a total width of 14.0 ± 0.1 , a body width of 6.1 ± 0.1 , and a pin pitch of 0.2 . Pin numbers 1 through 28 are indicated. A circular feature is shown on the left side of the body. The side view shows the package height and the lead profile. A detail view (DETAIL A) shows the lead profile with dimensions for the lead thickness, width, and angle. The land pattern recommendation shows the recommended dimensions for the solder pads on the PCB.

Top View Dimensions:

- Overall Width: 14.0 ± 0.1
- Body Width: 6.1 ± 0.1
- Pin Pitch: 0.2
- Pin 1 Location: 0.1 from left edge
- Pin 28 Location: 0.1 from right edge
- Pin 56 Location: 0.1 from top edge
- Pin 29 Location: 0.1 from bottom edge

Side View Dimensions:

- Lead Thickness: 0.1
- Lead Width: 0.5 TYP
- Lead Angle: $0^\circ - 8^\circ$
- Lead Height: $0.17 - 0.27$ TYP
- Lead Spacing: 0.13 (M) A B (S) C (S)

Land Pattern Recommendation:

- Lead Width: $0.09 - 0.20$ TYP
- Lead Spacing: $0.17 - 0.27$ TYP
- Lead Angle: $0^\circ - 8^\circ$
- Lead Height: $0.17 - 0.27$ TYP
- Lead Thickness: 0.1
- Lead Width: 0.5 TYP
- Lead Spacing: 0.13 (M) A B (S) C (S)

DETAIL A:

- Lead Thickness: 0.1
- Lead Width: 0.5 TYP
- Lead Angle: $0^\circ - 8^\circ$
- Lead Height: $0.17 - 0.27$ TYP
- Lead Spacing: 0.13 (M) A B (S) C (S)

MTD56 (REV B)

Technology Description

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